



BSI Standards Publication

Test methods for electrical materials, printed boards and other interconnection structures and assemblies

Part 5-3: General test methods for materials and assemblies — Soldering paste for printed board assemblies

National foreword

This British Standard is the UK implementation of EN 61189-5-3:2015. It is identical to IEC 61189-5-3:2015. It supersedes BS IEC 61189-5-3:2015, which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its secretary.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

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Amendments/corrigenda issued since publication

Date	Text affected
30 April 2015	This corrigendum renumbers BS IEC 61189-5-3:2015 as BS EN 61189-5-3:2015